

LFW



Packet No. EATNP156US

03-IMP-028

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

re **PATENT** application of:

Applicant: Michael Ioannou et al.  
Application No.: 10/786,660  
For: WAFER 2D SCAN MECHANISM  
Filing Date: February 25, 2004  
Examiner: Phillip A. Johnston  
Art Unit: 2881

**REPLY TO OFFICE ACTION DATED JUNE 24, 2005**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

Favorable reconsideration of the above-identified application is respectfully requested in view of the following remarks.